

General Description

The WSF55P06 is the highest performance trench P-ch MOSFETs with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSF55P06 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

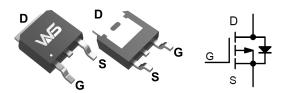
Product Summery

BVDSS	RDSON	ID
-60V	23mΩ	-50A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- CCFL Back-light Inverter

TO-252 Pin Configuration



Absolute Maximum Ratings (Tc=25℃unless otherwise noted)

Symbol	Parameter	Limit	Unit	
VDS	Drain-Source Voltage	-60	-60 V	
Vgs	Gate-Source Voltage	±20	V	
lσ	Drain Current-Continuous	-50	А	
l⊳(100°C)	Drain Current-Continuous(Tc=100°C)	-24.8	Α	
Ірм	Pulsed Drain Current	-220	А	
Po	Maximum Power Dissipation	110	W	
	Derating factor	0.73	W/°C	
Eas	Single pulse avalanche energy (Note 5)	273	mJ	
Тл,Тѕтс	Operating Junction and Storage Temperature Range	-55 To 175 ℃		
Rejc	Thermal Resistance, Junction-to-Case(Note 2)	1.36	°C/W	



Electrical Characteristics (Tc=25°C unless otherwise noted)

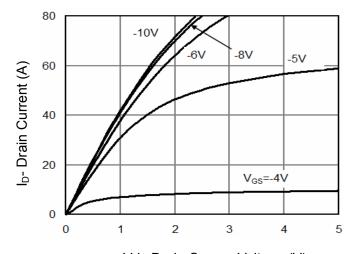
Symbol	Parameter	Condition	Min	Тур	Max	Unit
Off Characte	ristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =-250μA	-60			V
Inss	Zero Gate Voltage Drain Current	V _{DS} =-60V,V _{GS} =0V			-1	μΑ
Igss	Gate-Body Leakage Current	V _{GS} =±20V,V _{DS} =0V			±100	nA
On Characte	ristics (Note 3)					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} ,I _D =-250µA	-1	-1.8	-3.0	V
RDS(ON)	Drain-Source On-State Resistance	Vgs=-10V, Ip=-20A		23	28	mΩ
g FS	Forward Transconductance	V _{DS} =-5V,I _D =-20A		25		S
Dynamic Ch	aracteristics (Note4)			•	•	•
Clss	Input Capacitance			3017		PF
Coss	Output Capacitance	V _{DS} =-30V,V _{GS} =0V, F=1.0MHz		180		PF
Crss	Reverse Transfer Capacitance			126		PF
Switching C	haracteristics (Note 4)					
td(on)	Turn-on Delay Time	V_{DD} =-30V, RL=1.5Ω, V_{GS} =-10V,RG=3Ω		12		nS
tr	Turn-on Rise Time			15		nS
td(off)	Turn-Off Delay Time			38		nS
t _f	Turn-Off Fall Time			15		nS
Qg	Total Gate Charge	V _{DS} =-30,I _D =-20A, V _{GS} =- 10V		49.8		nC
Qgs	Gate-Source Charge			10.6		nC
Qgd	Gate-Drain Charge			13.6		nC
Drain-Source	e Diode Characteristics					
VsD	Diode Forward Voltage (Note 3)	V _G s=0V,I _S =-20A			-1.2	V
ls	Diode Forward Current (Note 2)				-50	Α
trr	Reverse Recovery Time	TJ = 25°C, IF =- 20A di/dt = -100A/µs(Note3)		47		nS
Qrr	Reverse Recovery Charge			53		nC

Notes:

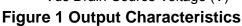
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300μ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** Eas condition: Tj=25 $^{\circ}$ C,VDD=-20V,VG=-10V,L=0.5mH,Rg=25 Ω

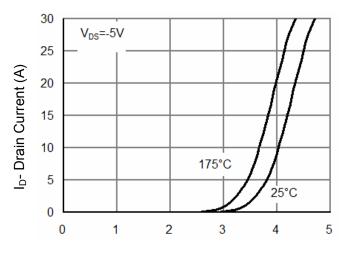


Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)





Vgs Gate-Source Voltage (V)

Figure 2 Transfer Characteristics

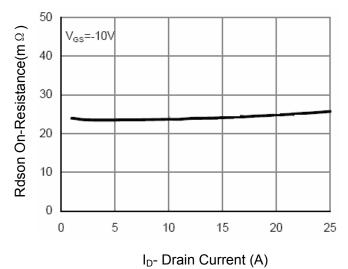


Figure 3 Rdson- Drain Current

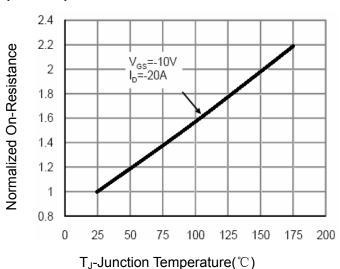
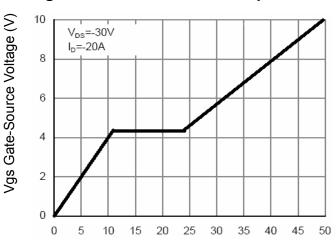


Figure 4 Rdson-Junction Temperature



Qg Gate Charge (nC)
Figure 5 Gate Charge

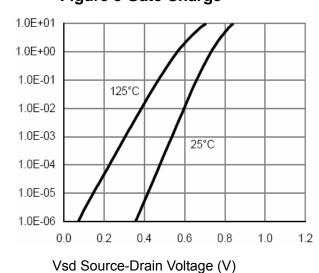


Figure 6 Source- Drain Diode Forward

Is- Reverse Drain Current (A)



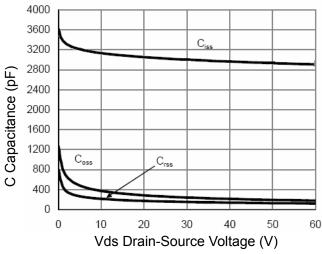


Figure 7 Capacitance vs Vds

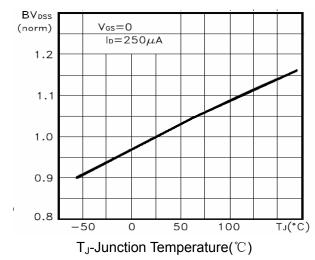


Figure 9 BV_{DSS} vs Junction Temperature

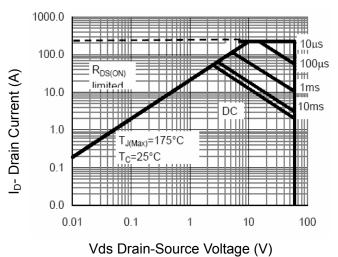


Figure 8 Safe Operation Area

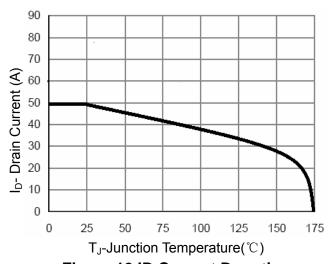


Figure 10 ID Current De-rating

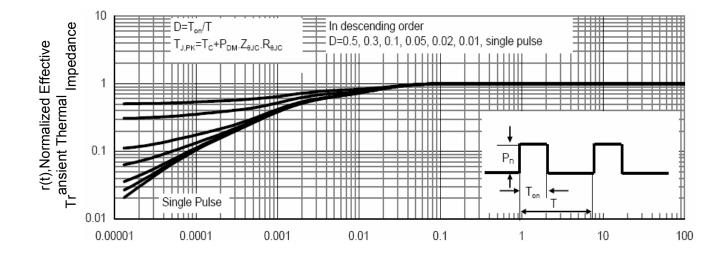


Figure 11 Normalized Maximum Transient Thermal Impedance

Square Wave Pluse Duration(sec)



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